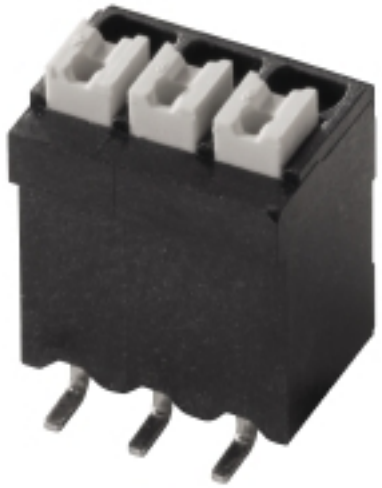
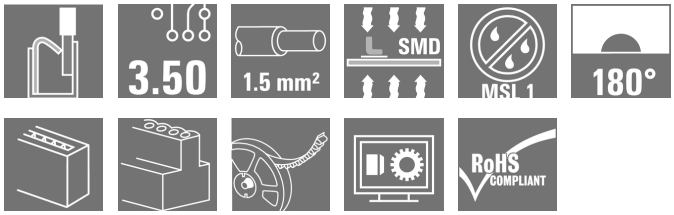
OMNIMATE Signal - series LSF
LSF-SMD 3.50/02/180 SN BK RL

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 16
D-32758 Detmold
Germany
Fon: +49 5231 14-0
Fax: +49 5231 14-292083
www.weidmueller.com

Product image



Similar to illustration



The innovative quick connector - simple, safe and economical:
PCB terminals with spring connection and direct PUSH IN technology. A milestone in connection technology. Amazingly simple and simply amazing in practice:

- Connect and easily detach solid wires or wires with wire-end ferrules without using tools
- Processed automatically in the reflow or vapour phase
- Potentials and clamping points marked clearly by coloured push buttons

World-class design-in and processing phases, and suitable for a vast range of applications.
PCB terminal for fully automatic assembly using reflow soldering (SMD), with PUSH IN wire connections. Conductor insertion and slider operation from the same direction (TOP).

- **Solid & flexible conductors with wire-end ferrules need only to be inserted and they are ready.**
- **When connecting stranded wires without wire-end ferrules the actuating element is used to open the terminal point**
- **Intuitive handling – since the wire-entry area and handling area are clearly separated.**
- **Packaged in tape-on-reel**
- **Conductor outlet direction 180°**

General ordering data

Type	LSF-SMD 3.50/02/180 SN BK RL
Order No.	1250360000
Version	Printed circuit board terminals, 3.50 mm, No. of poles: 2, 180°, black, PUSH IN, Clamping range, max. : 1.5 mm², Tape
GTIN (EAN)	4050118040999
Qty.	235 pc(s).
Product data	IEC: 320 V / 17.5 A / 0.2 - 1.5 mm² UL: 300 V / 12 A / AWG 24 - AWG 16
Packaging	Tape

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Technical data

Dimensions and weights

Width	7.7 mm	Width (inches)	0.303 inch
Height	16.3 mm	Height (inches)	0.642 inch
Height of lowest version	16.3 mm	Depth	10.5 mm
Depth (inches)	0.413 inch	Net weight	2.51 g

System parameters

Product family	OMNIMATE Signal - series LSF	Wire connection method	PUSH IN
Mounting onto the PCB	SMD solder connection	Conductor outlet direction	180°
Pitch in mm (P)	3.5 mm	Pitch in inches (P)	0.138 inch
No. of poles	2	Fitted by customer	No
Coplanarity:	100 µm	Number of solder pins per pole	2
Stripping length	8 mm	L1 in mm	3.5 mm
L1 in inches	0.138 inch	Touch-safe protection acc. to DIN VDE 0470	IP 20
Touch-safe protection acc. to DIN VDE 57 106	Safe from finger touch	Volume resistance	1.60 mΩ

Material data

Insulating material	LCP GF	Colour	black
Colour of operational elements	white	Material of operational elements	PPA GF
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
CTI	≥ 175	Insulation strength	≥ 10^8 Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact material	Copper alloy	Layer structure of solder connection	4-6 µm Sn matt
Storage temperature, min.	-25 °C	Storage temperature, max.	55 °C
Max. relative humidity during storage	80 %	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

Conductors suitable for connection

Clamping range, min.	0.13 mm²
Clamping range, max.	1.5 mm²
Wire connection cross section AWG, min.	AWG 28
Wire connection cross section AWG, max.	AWG 14
Solid, min. H05(07) V-U	0.2 mm²
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm²
Flexible, max. H05(07) V-K	1.5 mm²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.25 mm²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 mm²
w. wire end ferrule, DIN 46228 pt 1, min	0.25 mm²
w. wire end ferrule, DIN 46228 pt 1, max.	1.5 mm²

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Technical data

Clampable conductor	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.25 mm²	
	AEH	Stripping length	nominal	10 mm
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.34 mm²	
	AEH	Stripping length	nominal	10 mm
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.5 mm²	
	AEH	Stripping length	nominal	10 mm
	Cross-section for conductor connection	Type	fine-wired	
		nominal	0.75 mm²	
	AEH	Stripping length	nominal	10 mm
	Cross-section for conductor connection	Type	fine-wired	
		nominal	1.5 mm²	
	AEH	Stripping length	nominal	7 mm
Max. clamping range	1.5 mm²			

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. no. of poles (Tu=20°C)	17.5 A
Rated current, max. no. of poles (Tu=20°C)	16 A	Rated current, min. no. of poles (Tu=40°C)	17.5 A
Rated current, max. no. of poles (Tu=40°C)	14 A	Rated voltage for surge voltage class / pollution degree II/2	320 V
Rated voltage for surge voltage class / pollution degree III/2	160 V	Rated voltage for surge voltage class / pollution degree III/3	160 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	2.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 80 A

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1664286
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Wire cross-section, AWG, min.	AWG 28	Wire cross-section, AWG, max.	AWG 14
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (cURus)		Certificate No. (cURus)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	12 A	Rated current (Use group D / UL 1059)	10 A
Wire cross-section, AWG, min.	AWG 24	Wire cross-section, AWG, max.	AWG 16
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

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Technical data

Packing

Packaging	Tape	VPE length	25 mm
VPE width	330 mm	VPE height	330 mm
Tape depth (T2)	17.1 mm	Tape width (W)	24 mm
Tape pocket depth (K0)	16.6 mm	Tape pocket height (A0)	11.2 mm
Tape pocket width (B0)	9.5 mm	Tape pocket separation (P1)	16 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	11.5 mm
Tape reel diameter ⌀ (A)	330 mm	Surface resistance	Rs = 10^9 - 10^{12} Ω
Width Pick & Place Pad (W_{PPP})	7.5 mm	Length Pick & Place Pad (L_{PPP})	8.5 mm
Diameter of the withdrawal surface (ø D_{max})	9 mm		

Classifications

ETIM 3.0	EC001284	ETIM 4.0	EC002643
ETIM 5.0	EC002643	ETIM 6.0	EC002643
eClass 6.2	27-26-11-01	eClass 7.1	27-44-04-01
eClass 8.1	27-44-04-01	eClass 9.0	27-44-04-01
eClass 9.1	27-44-04-01		

Notes

Notes

- Additional push button colours on request
- Operating force of slider max. 40 N
- Rated current related to rated cross-section & min. No. of poles.
- Wire end ferrule with plastic collar to DIN 46228/4
- Wire end ferrule without plastic collar to DIN 46228/1
- P on drawing = pitch
- Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.
- Crimping shape "A" for wire end ferrules with PZ 6/5 crimping tool are recommended for the largest cable sizes.

IPC conformity: Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.

Approvals

Approvals

ROHS: Conform

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Technical data

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Brochure/Catalogue	FL DRIVES EN PI OMNIMATE LSF SMD EN FL ANALO.SIGN.CONV. EN MB DEVICE MANUF. EN FL DRIVES DE CAT 2 PORTFOLIOGUIDE EN FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL_INVERTER EN FL_BASE_STATION_EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN
Engineering Data	EPLAN, WSCAD
Engineering Data	STEP
SMT white paper	Download Whitepaper

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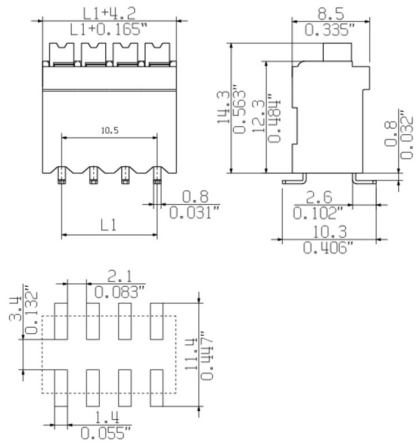
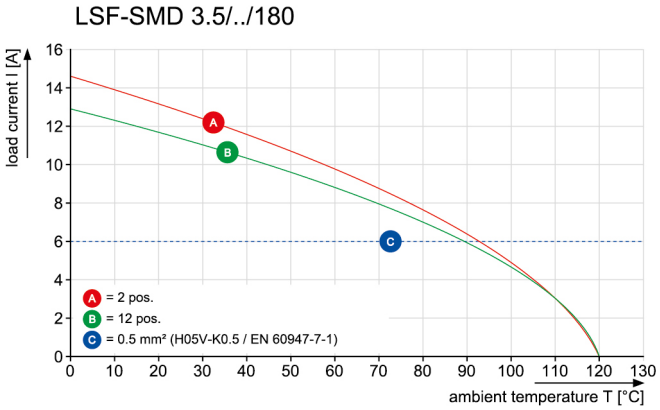
Drawings

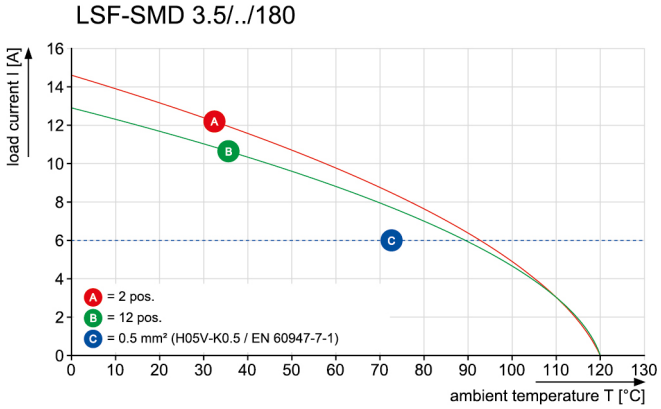
Dimensional drawing



Graph



Graph



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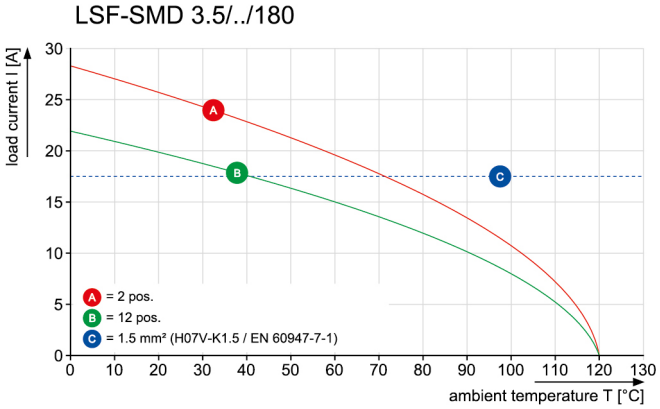
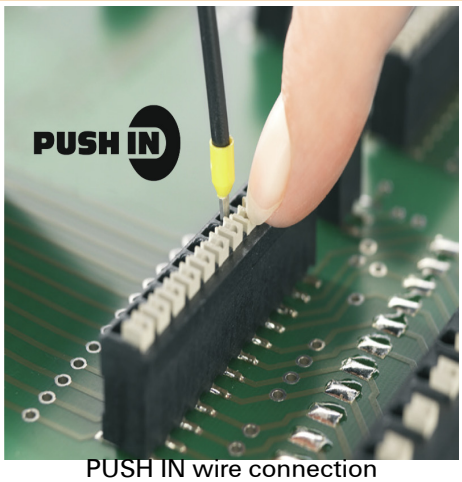


Stable solder connection

Product benefits



PUSH IN wire connection

Product benefits



Packaged in tape-on-reel

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Drawings

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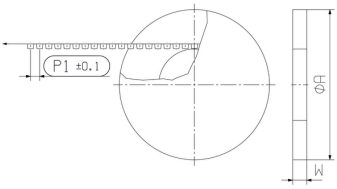
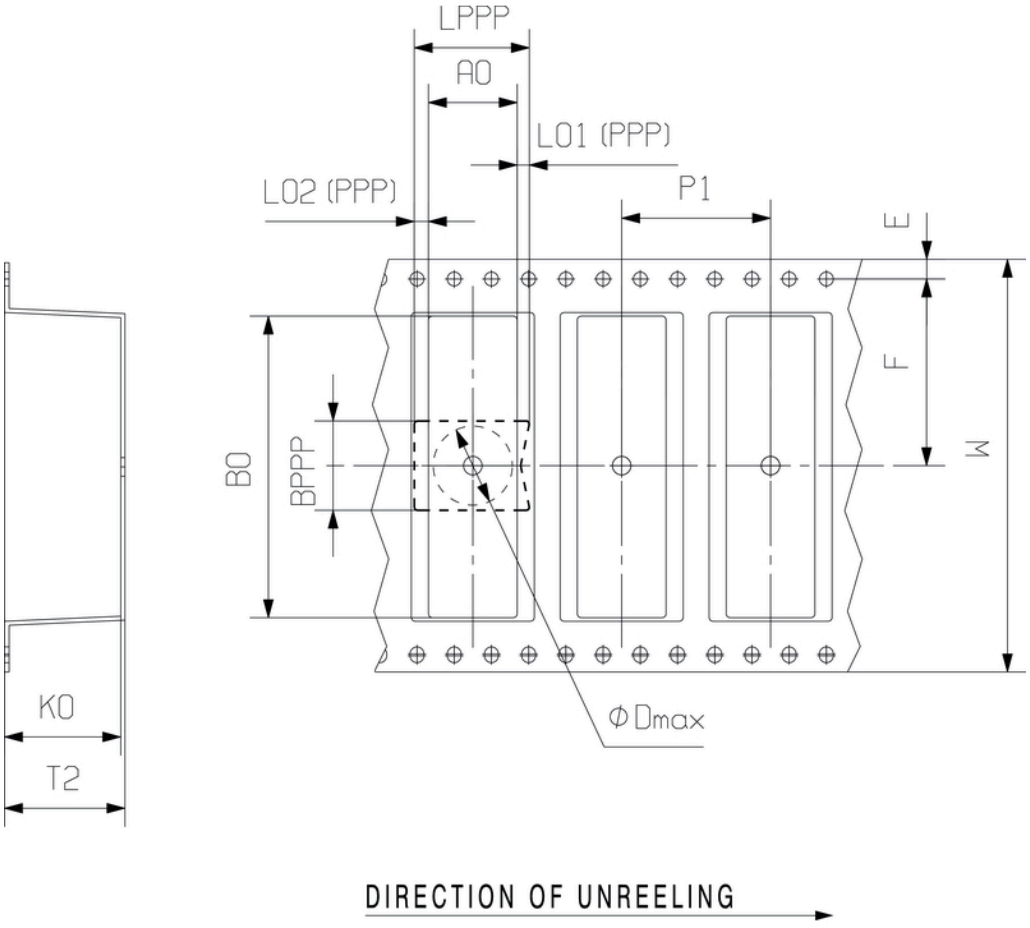


Dimensional drawing



Reflow Solder Profile

Recommended reflow soldering profile

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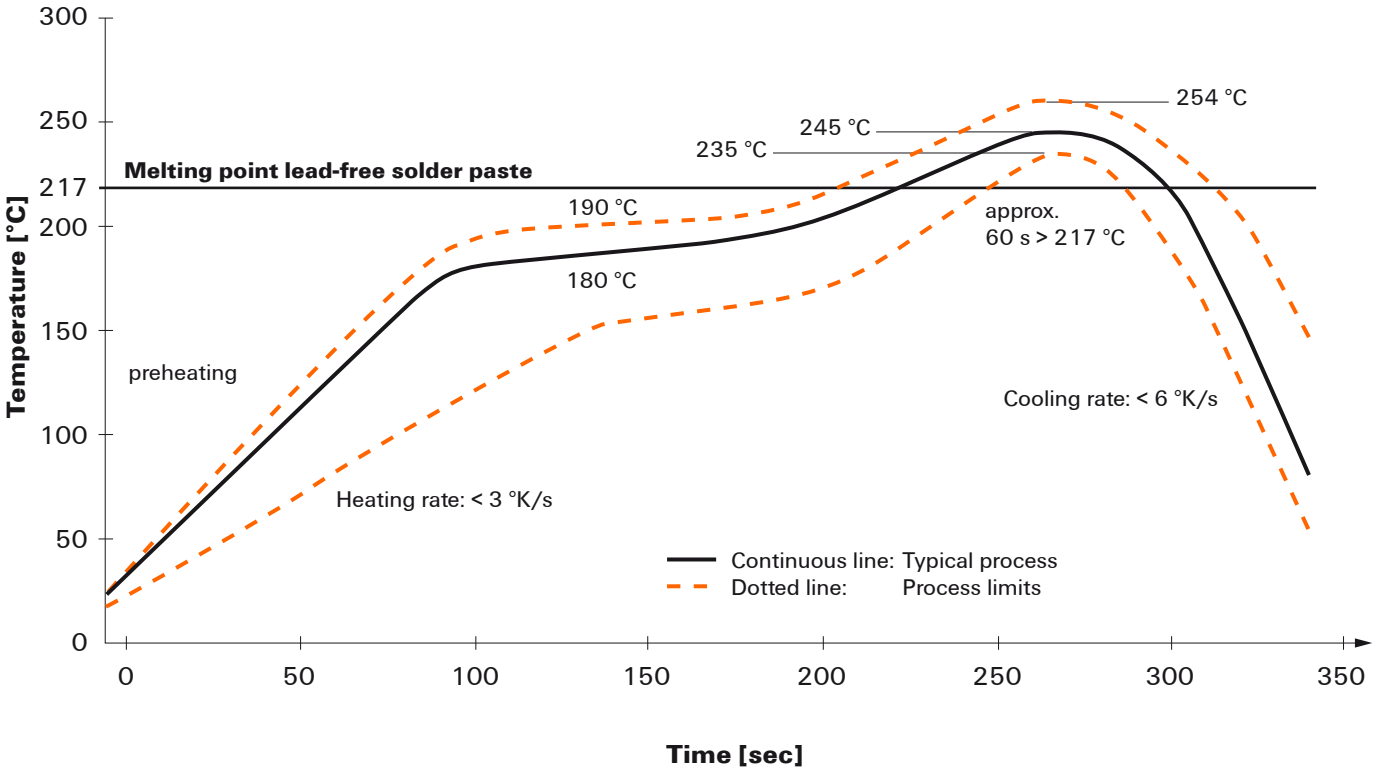

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:
- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically ≤ +3K/s. In parallel the solder paste is ‚activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at ≥ -6K/s solder is cured. Board and components cool down while avoiding cold cracks.

We reserve the right to make technical changes.